

Features:

- Isolated mounting base 3000V~
- Solder joint technology with increased power cycling capability
- Space and weight saving

Typical Applications:

- AC/DC Motor drives
- Various rectifiers
- DC supply for PWM inverter

V _{DSM} , V _{VRSM}	V _{DRM} , V _{VRRM}	品名
900V	800V	MD70TH80S
1100V	1000V	MD70TH100S
1300V	1200V	MD70TH120S
1500V	1400V	MD70TH140S
1700V	1600V	MD70TH160S
1900V	1800V	MD70TH180S

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _j (°C)	VALUE			UNIT
				Min	Type	Max	
I _{T(AV)}	Mean on-state current	180° half sine wave 50Hz Single side cooled, T _c =85°C	125			70	A
I _{T(RMS)}	RMS on-state current		125			110	A
I _{DRM} I _{RDM}	Repetitive peak current	at V _{DRM} at V _{RDM}	125			15	mA
I _{TSM}	Surge on-state current	10ms half sine wave	125			1.8	kA
I ² t	I ² t for fusing coordination	V _R =60%V _{RDM}				16.2	A ² s*10 ³
V _{TO}	Threshold voltage		125			0.75	V
r _T	On-state slope resistance					3.64	mΩ
V _{TM}	Peak on-state voltage	I _{TM} =210A	25			1.80	V
dv/dt	Critical rate of rise of off-state voltage	V _{DM} =67%V _{DRM}	125			1000	V/μs
di/dt	Critical rate of rise of on-state current	Gate source 1.5A t _r ≤0.5μs Repetitive	125			200	A/μs
I _{GT}	Gate trigger current	V _A =12V, I _A =1A	25	30		200	mA
V _{GT}	Gate trigger voltage			0.6		2.5	V
I _H	Holding current			10		250	mA
V _{GD}	Non-trigger gate voltage	V _{DM} =67%V _{DRM}	125			0.2	V
R _{th(j-c)}	Thermal resistance Junction to case	D.C. Single side cooled per chip				0.35	°C/W
R _{th(c-h)}	Thermal resistance case to heatsink	D.C. Single side cooled per chip				0.15	°C/W
V _{iso}	Isolation voltage	50Hz,R.M.S,t=1min,I _{iso} :1mA(MAX)		3000			V
F _m	Thermal connection torque(M5)			2.4		3.0	N·m
	Mounting torque(M6)			3.5		5.0	N·m
T _{vj}	Junction temperature			-40		125	°C
T _{stg}	Stored temperature			-40		125	°C
W _t	Weight				100		g
Outline	M16						

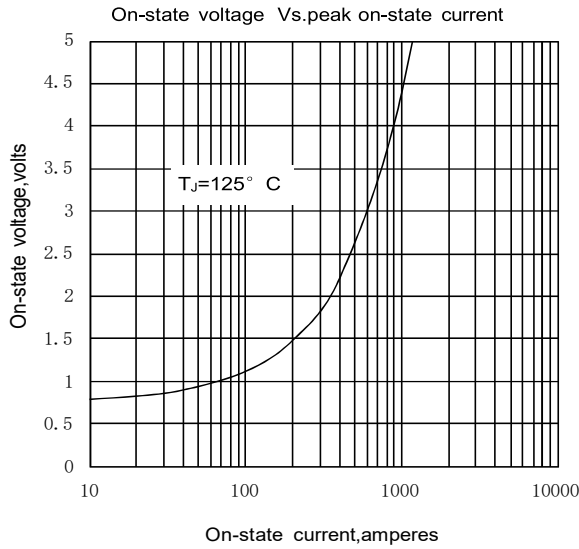


Fig1

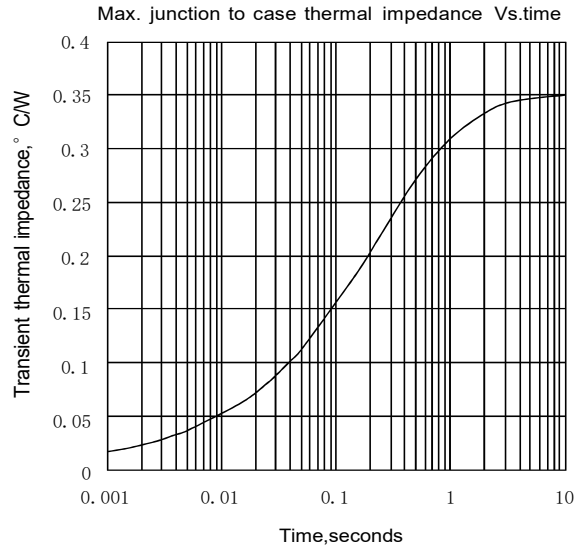


Fig2

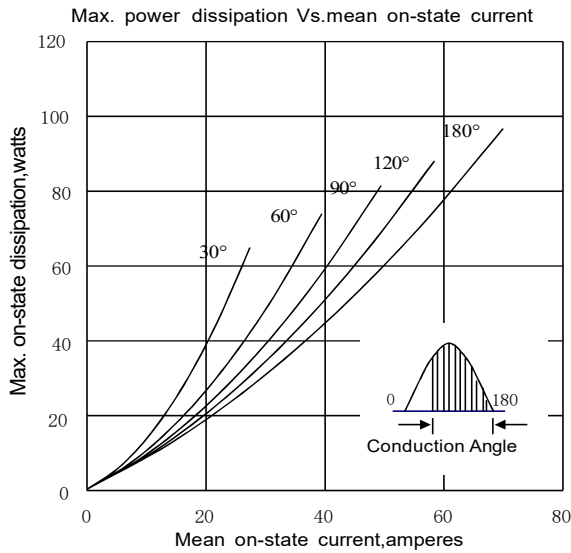


Fig3

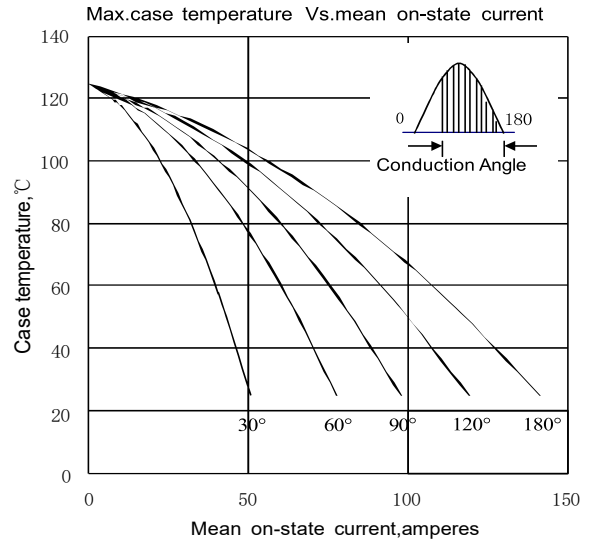


Fig4

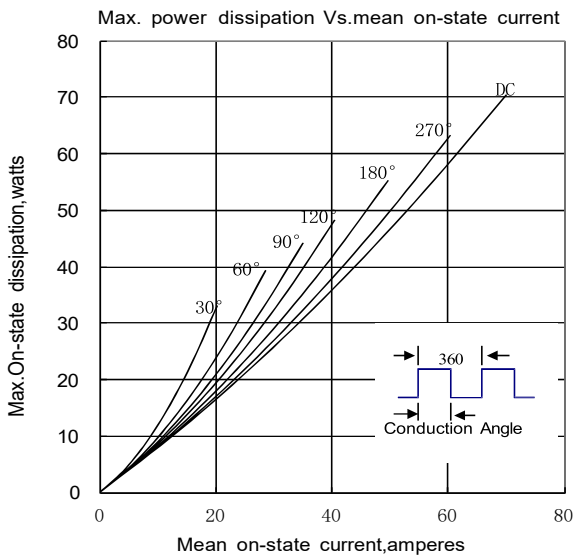


Fig5

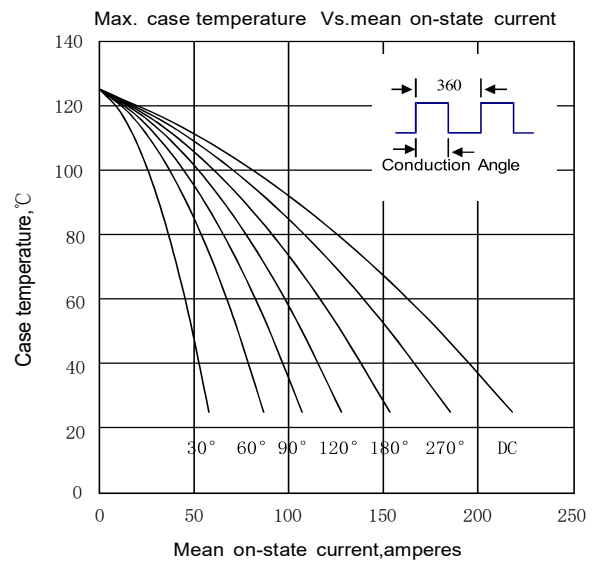


Fig6

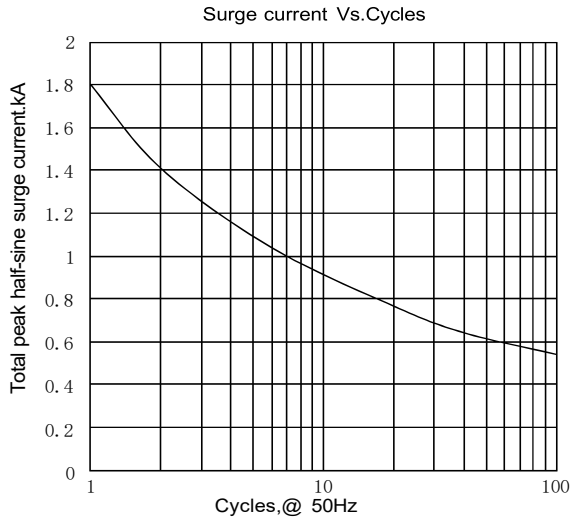


Fig.7

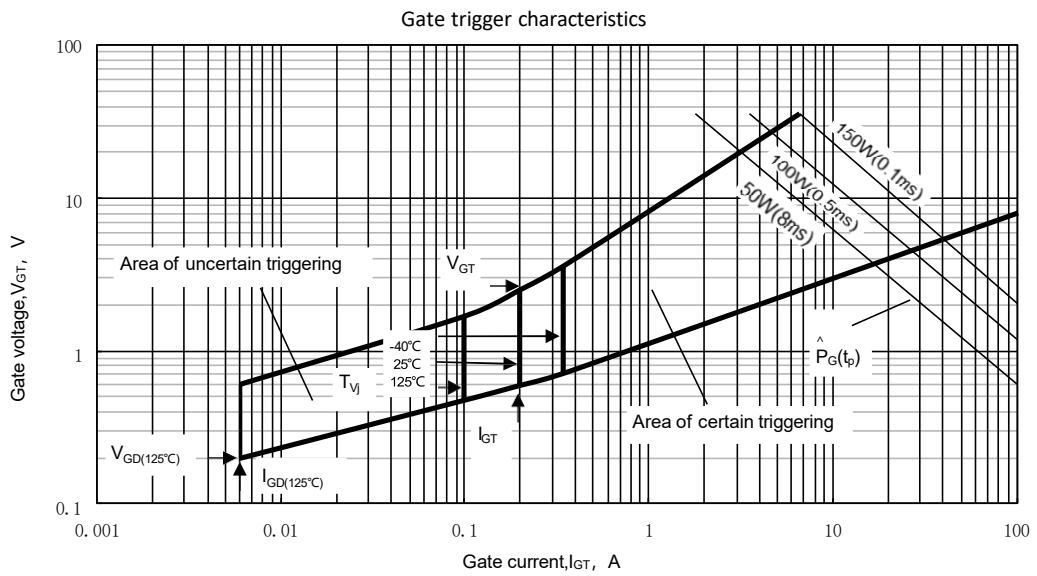
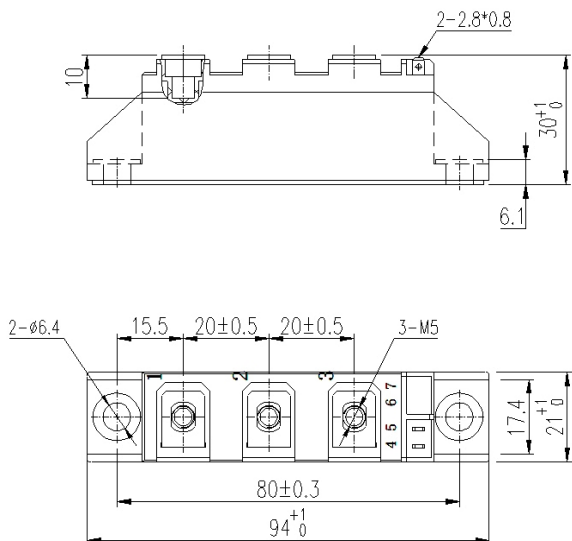
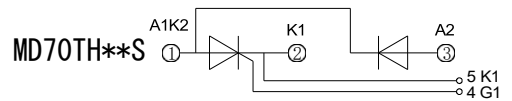


Fig. 8

Outline:



Unmarked dimensional tolerance: ±0.5mm



NIPS reserves the right to change specifications without notice.